Two-Phase Cooling of Targets and Electronics for Particle Physics Experiments Prof. John R. Thome

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Overview of Lecture, Topics and Sponsors:

Topics to be Addressed:

- Overview of two-phase cooling of electronics and computer chips.
- Videos of boiling in multi-microchannel cooling elements.
- Flow patterns in microchannels.

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- Design considerations to make two-phase cooling work.
- Heat transfer in a silicon cooling element with microchannels.
- Comparisons of two-phase vs. single-phase cooling of *targets*.

Sponsors of Microscale Two-Phase Flow and Heat Transfer at LTCM: Swiss National Science Foundatin, Swiss CTI agency, IBM, ABB, European Madame Curie, European Space Agency, etc.



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Who is the EPFL?: 2009 Shanghai Rankings in Engineering

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| usetts Institute of Technology University / of Illinois at Urbana- gn / of California, Berkeley | | 99 100 63 | 78 65 | 94 | 98 79 | 100 92.5 |
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| / of California, Berkeley | S222 | | 73 | 89 | 91 | 85.8 |
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| <u>Mellon University</u> | | 53 | 55 | 90 | 100 | 81.1 |
| / of Michigan - Ann Arbor | | 61 | 69 | 90 | 77 | 81.0 |
| ersity of Texas at Austin | | 73 | 63 | 86 | 71 | 79.8 |
| nstitute of Technology | | 35 | 81 | 86 | 91 | 79.7 |
| / of California, San Diego | | 68 | 58 | 90 | 75 | 78.9 |
| <u>ania State University -</u> / Park | | 69 | 68 | 84 | 70 | 78.8 |
| / of Southern California | | 60 | 51 | 91 | 83 | 77.4 |
| Institute of Technology | | 73 | 53 | 97 | 57 | 75.9 |
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Brief Description of LTCM Laboratory

<u>Staff</u>: (about 21 researchers not counting M.S. students)

• currently 14 Ph.D. Students and 3 M.S. students.

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- 6 post-doctoral reseachers.
- 2 technicians available more or less full time from pool.
- 1 prof. plus 2 secretaries.

Test facilities: (all with flow visualization)

One multi-channel microscale flow boiling test facility; Second multi-channel microscale flow boiling facility at IBM (CH); One single-channel microscale flow boiling test facility; One multi-microchannel condensing test facility; Air-water micro-channel and macro-channel test facilities; One macrochannel flow boiling test facility for macroscale flows; One falling film boiling and condensation test facility; One tube bundle boiling test facility;

One micro-PIV test setup to measure velocity profiles in one/two-phase flows; 3 high speed digital cameras (one up to 120k Hz) and 3 IR cameras.

Website of My Free Web e-Book on Heat Transfer:

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Engineering Data Book III:

a free e-book at website

www.wlv.com

Then go to the online book page. It includes 20 chapters on micro and macro scale single-phase and two-phase flow and heat transfer, over 200 videos in Chapter 1, an Excel calculation program, etc.

Desired Attributes of CO2 Two-Phase Target Cooler

- ✓ Low mass cooler (use microchannels in silicon)
- ✓ Low mass of coolant (two-phase fluid achieves this)
- ✓ Remove heat effectively (high h.t.c. for boiling fluid)
- ✓ Temperature uniformity (achievable)

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- ✓ Cool hotspots (achievable)
- ✓ Stable flow (achievable *but* requires dedicated attention)
- ✓ Handle transient heat fluxes (okay but requires study)
- ✓ Handle low temperatures (no problem for CO2)
- ✓ Work at low pressures (not feasible with CO2)
- ✓ Use stable non-corrosive fluid with long life (CO2 is fine)
- ✓ Very thin cooler design (channel heights limited)



Left: Pump-based system; Right: Compressor-based system. EAV refers to electronic actuated valve, AER refers to accumulator, heat exchanger and receiver components.

Models Required for Design of Micro-Evaporators

> Flow boiling model and flow pattern map: LTCM has 3-zone model and flow map.

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- Two-phase pressure drop and void fraction models for microchannels: Must cover laminar, transition and turbulent regimes for circular and rectangular channel shapes. LTCM has 1-d turbulence model for annular microchannel flows.
- CHF model for circular/non-circular, single and multi-channel heat sinks: LTCM has theoretical and empirical methods and is improving them.
- Stable two-phase flow with large scale instabilities: LTCM has method that stabilizes flow in our test sections with up to 134 parallel channels.
- > 3-d numerical modeling of conduction in heat sinks: commercial codes are okay.
- Temperature overshoots at startup: LTCM has limited data and a passive method to avoid overshoot, and has patented an active method to avoid them.
- Numerical model to simulate distribution of single and two-phase flows in the inlet and outlet headers: LTCM is working on this.
- > Transient simulation capability and hot spots: LTCM has limited data on first topic; has first method to simulate CHF at hot spots and just now first data too.
- > Comprehensive simulation tool has been developed within LTCM.

Backflow/Instability in Parallel Microchannels:

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Qu and Mudawar (Purdue) diagram: backflow into inlet header, flow maldistribution and unstable flow. *Needs solution!*





CPU Microchannel Flow Boiling Cooling at LTCM

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Multi-microchannel evaporator in copper fabricated at LTCM: 20 channels (0.45 x 4.0 mm) and dissipates 340 W/cm² with a low pressure refrigerant as coolant (*LTCM PhD thesis of J.E. Park (2008*).

Video at High Heat Flux in Copper: Poor Flow Distribution



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Maximum heat flux dissipation possible is only about 115 W/cm² (as a result of mal-distribution and back flow, there is over heating in liquid starved/ dry area!). Video of LTCM.



Video at High Heat Flux in Copper: Good Flow Distribution

2000 i/s 1/12500 sec +00:00:00.000000sec Tout=21C Tin=10C G=650kg/m2s Q=250W/cm2 Fluid=R134a

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Maximum heat flux dissipation possible is at least 340 W/cm² using inlet flow restrictions to prevent back flow and create uniform flow distribution (shown here at 250 W/cm² at 2000 images/sec). Video of LTCM.



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Flow Patterns in a 0.5 mm Diameter Channel: Videos at exit of microchannel & boiling data from Consolini Ph.D. thesis at EPFL (2008).









Analysis of CHF of Hotspots on Computer Chips



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Revellin-Thome (2007): 1-d numerical model applied to prediction of local CHF at hotspots in micro-channels with micro-scale boiling.



(e) $q_{\text{HS}} = q_{\text{HS, max}} = 3000 \text{ kW/m}^2$. Dryout occurs at the hot spot location.

Hot spot heat flux as a function of the hot spot size located at the midpoint along the circular microchannel for D=0.5 mm, G=500 kg/m²s, $T_{sat}=30^{\circ}$ C, $L_{MEV}=20$ mm and the local hot spot situated at the midpoint along the microchannel.

Local time averaged heat transfer flow boiling model



 $h(z) = \frac{t_l}{\tau} h_l(z) + \frac{t_{film}}{\tau} h_{film}(z) + \frac{t_{dry}}{\tau} h_v(z)$

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> Three-zone flow boiling model of Thome, Jacobi and Dupont: time averaging of dynamic heat transfer coefficients gives local heat transfer coefficient (7 fluids from 7 labs in original data base, now 5 more fluids).

(in Int. J. Heat Mass Transfer, 2004)







transfer coefficients go over 100'000 W/m²k using a *refrigerant*, not *water*.



Above graph shows some local base temperatures at various heat fluxes with one inlet and two outlets (up to 256 W/cm²). CHF not reached with this test section with 134 channels. Notice the nearly uniform, low temperatures that can be achieved.







M.S. Thesis of Madhour: Test Section & Results

4.5

3.5

3

2.5

2

1.5

4

2

3



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Footprint heat transfer coefficient map [W/m2K]. Mass velocity of 1000 kg/m²s, qb = 184 W/cm².

Heater chip surface temperature map [K]. Mass velocity of 900 kg/m²s, qb = 182 W/cm².

4

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7

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Simulation of Micro-Evaporator Performance of CERN GigaTracKer: Geometry and Dimensions



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Parametric study

In all cases, the base thickness, *e*, will be zero, thus showing a best-case scenario as any additional material added can be accounted for in separate calculations.

The GTK should not see a temperature difference along its length of more than 5°C while being kept as cold as possible (~ -30°C).

Assumptions made for the present simulations are: (1) the evaporator is uniformly heated from the bottom with a base heat flux of q_b , (2) the flow through the cooler is uniformly distributed between all the channels, (3) the top of the cooler is adiabatic and (4) for two-phase flow, no inlet subcooling is used. Cooler is 60mm by 30mm long.

Simulations for Development of CERN GigaTracKer

The models used for single-phase heat transfer and pressure drop are those from Shah and London, while the three-zone model and homogeneous model were used for the two-phase heat transfer and pressure drop, respectively.

The fluids to be simulated are radiation-hard fluorocarbons and CO₂:

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•For temperatures below -10°C, the best choice of fluid would be between CO_2 and C_2F_6 but possibly also C_3F_8 .

•The most common cooling fluid used at CERN is C_6F_{14} and is used in singlephase flows only. This fluid is not ideal for two-phase cooling as it is a lowpressure fluid, having a saturation temperature of 56 °C at atmospheric pressure, implying that the system would need to be under vacuum for lower temperatures. This has the disadvantage that one is limited by the allowable pressure drop within the cooling device, implying that channels should be relatively large. The potential of air also leaking into the system becomes greater.

* Thus, for two-phase cooling: CO₂, C₂F₆ and C₃F₈ will be compared.



Figure 7: Effect of *channel width* and *fin height* on *maximum base temperature* difference relative to the inlet and on pressure drop for single-phase flow using C_6F_{14} relative to 50 microns width or height for fixed fin thickness of 25 microns.



Figure 9: Effect of *fin height* on *maximum base temperature difference relative to inlet* and on *pressure drop* for two-phase flow for channel width of 50 microns and fin thickness of 25 microns. Simulation shows that CO2 is the best candidate.



The pressures are shown in terms of the ratio of the local pressure to the inlet pressure. The actual base temperature varies depending on the heat transfer/pressure drop/vapor pressure curve of the fluid. Smallest temp. variation is for CO_2 . Pressure drops are also significantly less for CO_2 and C_2F_6 since their viscosities are about half that of C_3F_8 .

Figure 10 shows a comparison of single-phase to two-phase cooling. Both single-phase C_6F_{14} and two-phase fluid CO_2 have an inlet temperature of -30°C. The fin height and channel width were 50 µm, while the fin thickness was 25 µm. A base heat flux of 2 W/cm² was applied. The actual junction/base temperature and fluid pressure along the channel are shown.

Comparison of Single-Phase to Two-Phase Cooler

For both the single-phase and two-phase results, the axial temperature difference is below 5K, although the increase in temperature for the two-phase fluid is much less than for the single-phase fluid (0.14K vs. 4.7K).

The difference in the fluids' pressure drops is even more significant:

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* The single-phase fluid requires a mass flux of 4500 kg/m²s to obtain a temperature difference below 5K with a pressure drop of about 700 kPa!

* The two-phase fluid only required a mass flux of 250 kg/m²s that resulted in a pressure drop of 60 kPa.

The power required to move the two fluids is 1984 mW and 28 mW, respectively.

Simulation implies that CO2 two-phase cooling relative to C6F14 singlephase cooling yields much lower axial temperature gradients in the GTK, lower pressure drops and pumping power consumption, and very high heat transfer coefficients but is more complex to implement.

CMOSAIC: 3D-IC Thermal Performance with Microscale Liquid/Evaporative Cooling

- A 3D computer chip with integrated cooling system is expected to:
 - Overcome the limits of air cooling

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- Compress ~10¹² nanometer sized functional units (1 Tera) into one cubic centimeter: nearing the equivalent in human brain
- Yield 10 to 100 fold higher connectivity
- Cut energy consumption

A new \$4.3million Swiss consortium project lead by Prof. Thome

Summary and Advantages:

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Flow boiling in micro-evaporator elements is a convincing solution for cooling high energy physics targets and electronics rather than a viscous liquid because:

- It yields much larger heat transfer coefficients,
- It makes low temperature difference operation possible,
- It has high critical heat fluxes for high W/cm² operation,
- It provides a near uniform temperature of cooled element,
- Hot spot cooling is self-compensated by boiling itself,
- It has lower pumping power vs. single-phase cooling,
- Evaporation at -20°C to -30°C is not a problem,
- **But** two-phase cooling is more complex to implement *but* we have significant experience with it.

Two-Phase Flow in T-Junction:

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- 1. VOF (step one)
- 2. VOF with level set (step two)
- 3. Other improvements (step three)
- 4. Validation

This is an ongoing Ph.D. thesis and hence are preliminary results. Written within *Fluent*.

Static conditions without vapor shear. Left: reference system and nomenclature; Right: example of solutions obtained for equilateral triangle and rectangle with R-22 fluid, saturation temperature $T_{sat} = 30^{\circ}$ C, cross sectional void fraction ϵ =0.8, gravity acceleration g=9.81 m/s².

Film Condensation: Microchannel without Vapor Shear

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Annular flow without vapor shear. Left: mean heat transfer coefficient (h) versus cross sectional void fraction (e) for circular channels with different hydraulic diameters, different imposed ΔT at the wall and different levels of gravity; Right: mean heat transfer coefficient for different test section shapes with hydraulic diameter of 1mm, $\Delta T = 0.5$ K, g=9.81 m/s²; the test fluid is HFE7100 in all the cases.

Microscale Flow and Heat Transfer Course:

FUNDAMENTALS OF MICROSCALE HEAT TRANSFER: BOILING, CONDENSATION, SINGLE-AND TWO-PHASE FLOWS

Date: June 7-11, 2010 at EPFL in Lausanne.

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Lecturers: Thome (EPFL), Michel (IBM Research), Celata (ENEA), Zun (Univ. of Ljubljana), Jacobi (Univ. of Illinois).